

Product Specification [产品规格书]:	ISSUED BY: Engineering Dept			
Subject [主题]:	Date Issued	2017/07/31		
1.50mm Pitch 1511 Series Connector Specification	Date Revised	2018/01/24		

This specification is referred to the 1.50mm series wire to board connector

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【1.适用范围 Scope】

此种规格包括 1.50mm Pitch 1511 Series 连接器规格说明.

This Specification Covers the 1.50mm Pitch 1511 Series Connector Specification.

【2.规格与料号 Spec and Part number】

规格内容	产品料号
Specification	Production No.
端子/Terminal	1511T-HXX-01
胶壳/Housing	1511H-2*10-PT
针座/Wafer	1511WRS-2*10HX-LPXXX 1511WVS-2*10HX-LPXXX

【3.材质与表面处理 Disposal of Material and surface】

规格内容		材 质	表面处理
Specification		Materials	Disposal of Surface
端子/Terminal		High conductivity copper	Nickel: Over 30μ″. Tin: Over 70μ″
胶壳/Housing		PBT	UL 94V-0
Base 针座/Wafer		LCP	UL 94V-0
VI 产/ Walei	PIN	High conductivity copper	Over Tin 70µ″ or Gold Flash / Over 30µ″ Nickel

⁽上述参数请以工程图为准/Please Refer to the Project drawing for the above Specification)

【4. 额定等级 Ratings and applicable wires】

项 目【Item】	规 格【Standard】		
额定电压 Rated Voltage (Max.)	350V	[\(\C \D C \)	
额定电流 Rated Current (Max.)	ent (Max.) 4A [AC/DO		
使用温度范围 Ambient temperature Range	e -40°C~+105°C		
适用线径 Applicable wire insulation O.D	AWG #24~28 Insulation O.D. 1.10mm(Max.)		

【 *升温时含端子.Including terminal temperature rise. 】

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【5.性能 PERFORMANCE】

5-1. 电气的性能 Electrical Performance.

	[Item]	【Test Condition】	[Requirement]			
5-1-1	接触阻抗 Contact Resistance	公母配合,开放电压 20mV 以下,电流 10mA 检测连接器 A~B 区. Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	Initial: 20 milliohms Max. After Test: 40 milliohms Max.			
5-1-2	绝缘阻抗 Insulation Resistance	公母配合,在相邻端子,端子与地片之间,使用500V的直流电,检测连接器. Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon EIA-364-21B / MIL-STD-202 Method 302 Cond.B)	1000 Megohms Min.			
5-1-3	耐电压 Dielectric Strength	公母配合,在相邻端子,端子与地片之间,使用500V的交流电1分锺,检测连接器. Mate connectors, apply 500V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A / MIL-STD-202 Method 301)	不出现中断等情况 No Breakdown and Flashover			
5-1-4	铆线后端子接 触阻抗 Contact resistance on crimped portion	铆线后之端子,开放电压 20mV 以下,电流 10mA 检测连接器. Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	10 milliohms Max.			



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5-2. 机械的性能 Mechanical Performance.

	项 目 【Item】	条 件 【Test Condition】	规 格 【Requirement】
5-2-1	插拔力 Insertion & Retention Force	以每分锺 25.4±3mm 的速率插入和拔出. Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.	参照第 6 项 Refer to paragraph 6
5-2-2	端子保持力 Terminal/ Housing Retention Force	以每分 25.4±3mm 的速率,将端子从 Housing 内轴向拔出的力量. Apply axial pull out force at the speed rate of 25.4±3mm/minute on the terminal assembled in the housing.	7.84N {0.8kgf} Min.
5-2-3	端子插入力 Terminal Insertion Force	铆线后之端子插入 Housing 所需最大力量. Insert the crimped terminal into the housing.	9.8N {1.0kgf} Max.
5-2-4	Pin 针保持力 Pin Retention Force	以每分 25.4±3mm 的速率,将 PIN 针从Wafer 内轴向拔出的力量. Apply axial push force at the speed rate of 25.4±3mm/minute.	9.8N {1.0kgf} min.



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	项目	条 件	规		格	<u> </u>	
	【Item】	[Test Condition]	【Re	quir	eme	nt]	
		固定铆线后的端子,使电线与端子分离时所	AWG	#24	#26	#28	
5-2-5	端子压着强度 Tensile strength	需的最小力量. Fix the crimped terminal, apply axial pull out force on the wire. (Do not crimp insulation part).	Spec.kgf. Min.	3.0	2.0	1.0	
	(Crimped connections)		Note> As f sizes in define v	this s	specit	ficatio	n

<u>5-3. 环境性能及其它 Environmental Performance and Others.</u>

项 目		条 件	规	格
[Item]		[Test Condition]	[Requirement]	
5-3-1	重复插拔 Repeated Insertion/ Withdrawal	以每分锺不超过 10 次的速率,将公母插拔30 次. When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触阻抗 Contact Resistance	40 milliohms Max.
5-3-2	温升测试 Temperature Rise	公母对插后,在通过额定电流下,所测定的温度. Carrying rated current load. (UL 1977)	温升测试 Temperature rise	30°C Max.
5-3-3	耐振动性 Vibration	振幅: 1.5mm P-P 时间: 10~55~10 HZ in 1 minute 持续时间: 每轴向 2 小时 Amplitude: 1.5mm P-P Sweep time: 10~55~10 HZ in 1 minute Duration: 2 hours in each X.Y.Z axials. (Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	外观 Appearance	无异状 No Damage
			接触阻抗 Contact Resistance	40 milliohms Max.
			瞬断 Discontinuity	1 micro- second Max.
	耐冲击性 Shock	在 X.Y.Z 上 6 个方向上,以 490m/s ² (50g 的	外观	无异状
			Appearance	No Damage
5-3-4		力量)冲击下各 3 回.490m/s²{50G}, 3	接触阻抗 Contact	40 milliohms Max.
		strokes in each X.Y.Z. axes.	Resistance	
		(Based upon EIA-364-27B/MIL-STD-202 Method 213B Cond.A)	瞬断 Discontinuity	1 micro- second Max.



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	项 目		条 件	规 格	
[Item]		Item]	Test Condition	[Requirement]	
		耐热性 Heat Resistance	105±2°C,96 hours. (Based upon MIL-STD-202 Method 108A Cond.A)	外观 Appearance	无异状 No Damage
	5-3-5			接触阻抗 Contact Resistance	40 milliohms Max.
	F 2 6	耐寒性 Cold Resistance	-40±5°C,96 hours. (Based upon EIA-364-105)	外观 Appearance	无异状 No Damage
	5-3-6			接触阻抗 Contact Resistance	40 milliohms Max.
•		一 耐湿性	温度: 40±2°C 湿度: 90~95%(RH) 持续时间: 96 hours Temperature: 40±2°C Relative Humidity: 90~95% Duration: 96 hours (Based upon EIA-364-31A/MIL-STD-202 Method 103B Cond.B)	外观 Appearance	无异状 No Damage
5-3-	F 2 7			接触阻抗 Contact Resistance	40 milliohms Max.
	5-5-7	Humidity		耐电压 Dielectric Strength	Must meet 5-1-3
				绝缘阻抗 Insulation Resistance	100 Megohms Min.
		温度变化 Temperature Cycling	从-40°C持续 30 分锺升至+105°C持续 30 分锺,循环 5 次. 5 cycles of: a) -40°C 30 minutes. b) +105°C 30 minutes. (Based upon EIA-364-32B)	外观 Appearance	无异状 No Damage
	5-3-8			接触阻抗 Contact Resistance	40 milliohms Max.
		9 盐水喷雾 Salt Spray	在温度 35±2°C,盐水浓度 5±1%下,盐水喷雾 24±1 小时. 24±1 hours exposure to a salt spray from the 5±1% solution at 35±2°C. (Based upon EIA-364-26B/MIL-STD-202 Method 101D Cond.B).	外观 Appearance	无异状 No Damage
5-3-9	5-3-9			接触阻抗 Contact Resistance	40 milliohms Max.
		焊锡附着性 Solder- ability			浸渍面积需 95%以上
5-3-10					95% of
	5-3-10		Soldering Time: 3~5second.	Solder Wetting	immersed area
			Solder Temperature: 245±5°C.		must show no voids, pin
			(Based upon EIA-364-52)		holes.



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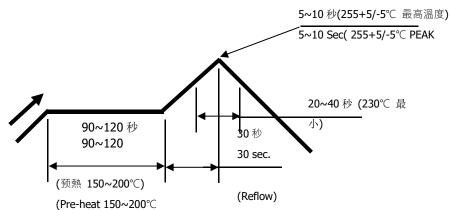
项 目		条 件	规	格
【Item】		【Test Condition】	【Require	ement】
5-3-11	焊锡耐热性 Solder- Resistance	焊接时间: 5~10 秒. 焊接温度: 255+5/-5℃. Soldering time:5~10 sec solder. Temperature:255+5/-5℃. (Based upon EIA-364-56A)	外观 Appearance	无异状 No Damage

【6.综合插入力及拔出力 INSERTION/WITHDRAWAL FORCE】 < Connector mating force >

PIN 数 No. of CKT		30 次拔出力(最小值) 30 th Withdrawal (kgf Min.)	PIN 数 No. of CKT	1	30 次拔出力(最小值) 30 th Withdrawal (kgf Min.)
2*10	5.50	0.50			

注: 以上插拔次数为 30 次 Note: Insertion and Withdrawal for 30Cycles

【7. SMT 回流条件 SMT REFLOW CONDITION】



温度条件曲线图/ 基板上温度

TEMPERATURE CONDITION GRAPH/ (TEMPERATURE ON BOARD PATTERN SIDE)

注记:由于 P.C 板等焊接装置改变条件,所以请预先用自己的装置检查回流焊的条件.

Notes: Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, P.C. boards, and so on.